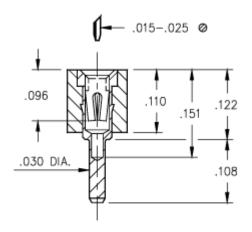
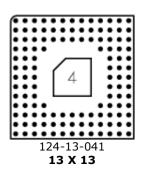


# **DATA SHEET**

Product Number: 515-13-124-13-041001





### **Description:**

PGA Socket Low Profile Solder Tail Through Hole Accepts .015-.025" Leads

Plating Code:

13

**Shell Plating:** 

10  $\mu^{\text{\tiny{II}}}$  Gold over 100  $\mu^{\text{\tiny{II}}}$  Nickel

**Inner Contact Plating:** 

30  $\mu$ " Gold over 50  $\mu$ " Nickel

# Of Pins	Mill-Max Part Number	RoHS Compliant
124	515-13-124-13-041001	RoHS 2002/95 EC

#### **CONTACT:**

Contact Used: #32, Low Force 6 Finger Contact

Current Rating = 3 Amps

**BERYLLIUM COPPER ALLOY** 172 (UNS C17200) per ASTM B 194

#### **Properties of BERYLLIUM COPPER:**

• Chemical composition: Cu 98.1%, Be 1.9%

• Temper as stamped: TD01

Properties after heat treatment (TH01):

Hardness: 36-43 Rockwell CMechanical Life: 100 Cycles Min.

Density: .298 lbs/in3

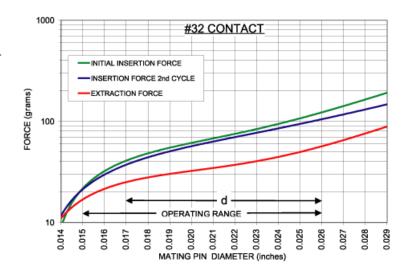
Electrical Conductivity: 22% IACS\*

• Resistance: 10 miliohms Max

• Operating Temperature: -55°C/+125°C

• Melting point: 980°C/865°C (liquidus/solidus)

 $\bullet$  Stress Relaxation†: 96% of stress remains after 1,000 hours @ 100 °C; 70% of stress remains after 1,000 hours @ 200 °C



†Since BeCu loses its spring properties over time at high temperatures; it is rated for continuous use up to 150°C. For applications up to 300°C, Mill-Max offers many contacts in Beryllium Nickel. Contact Tech Support for more info.

<sup>\*</sup>International Annealed Copper Standard, i.e. as a % of pure copper.

#### **LOOSE PIN:**

Loose Pin Used: 0501

BRASS ALLOY (UNS C36000) per ASTM B 16

## **Properties of BRASS ALLOY:**

• Chemical composition: Cu 61.5%, Zn 35.4%, Pb 3.1%†

• Hardness as machined: 80-90 Rockwell B

• Density: .307 lbs/in3

• Electrical conductivity: 26% IACS\*

• Melting point: 900°C/885°C (liquidus/solidus)

†(3 to 4% lead is used to permit "free machining" and is permitted by EC Directive 2002/95Annex 6; so all pin materials are RoHS compliant)

#### **INSULATOR INFORMATION:**

PCT Polyester, (Thermx CG933, black)

High Temperature

## **Properties of PCT Polyester:**

Brand: ThermxGrade: CG-933

• Rated voltage: 100 VRMS/150 VDC

• Insulation resistance: 10,000 Megaohms min.

• Material Heat Deflection Temp (per ASTM D 648): 529°F (276°C) @ 66 psi

• Dielectric strength: 1000 VRMS min. (700 VRMS min. for series 117 Shrink DIP)

Note: Materials above 446°F (230°C) are considered suitable for "eutectic" reflow soldering, above 500°F (260°C) for "lead-free" reflow soldering.

<sup>\*</sup>International Annealed Copper Standard, i.e. as a % of pure copper.